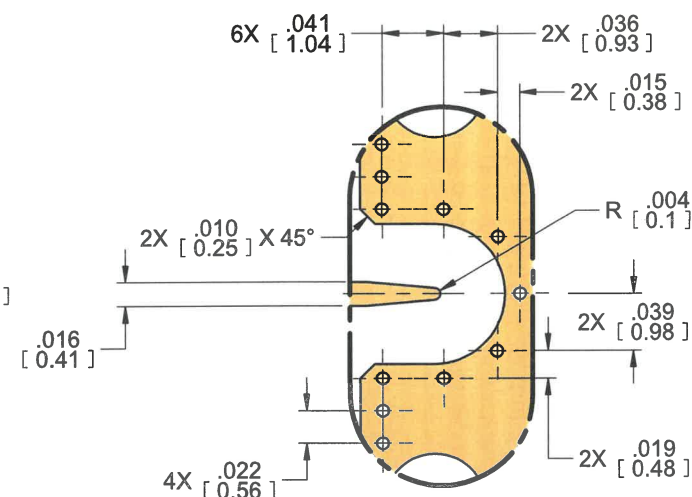
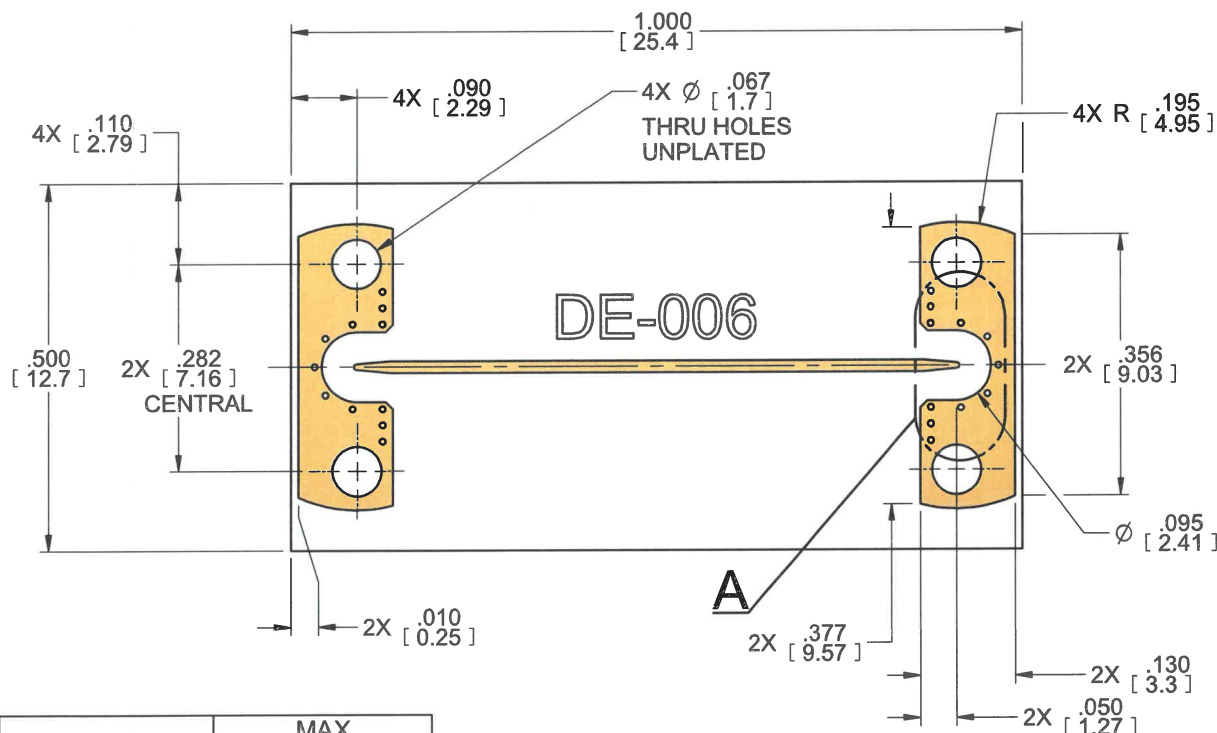


B4003-8VM-40

DOCUMENT
CONTROL

JUL 16 2020



LAYER STACK-UP

Diagram illustrating the cross-section of a two-layer PCB structure:

- LAYER 1 PRIMARY (TOP) SIDE**
 - Material: .002" 1/2 oz Cu CONDUCTOR
 - Core: .008" ROGERS RO4003 CORE
- LAYER 2 GROUND PLANE**
 - Material: .002" 1/2 oz Cu CONDUCTOR

Additional labels on the right side of the diagram:

- ← AIR ABOVE RF TRACE
- ← .002" 1/2 oz Cu CONDUCTOR
- ← .008" ROGERS RO4003 CORE
- ← .002" 1/2 oz Cu CONDUCTOR

DETAIL A

MATERIAL: RO4003™

2. THIS TRANSITION IS OPTIMIZED TO HAVE THE END LAUNCH CONNECTOR ELECTRICALLY CONNECTED TO LAYER 1 (TOP) AND LAYER 2 (GROUND). THE ELECTRICAL PERFORMANCE WILL SIGNIFICANTLY REDUCE IF ADDITIONAL SUBSTRATE AND CONDUCTOR LAYERS ARE PLACED BETWEEN LAYER 2 AND THE END LAUNCH CONNECTOR, EVEN IF PLATED.

1. ALL DIMENSIONS ARE IN INCHES. ALL ANGLES ARE IN DEGREES. DIMENSIONS SHOWN IN BRACKETS [XXX] ARE IN MILLIMETERS.

NOTES: UNLESS OTHERWISE SPECIFIED.



Southwest Microwave, Inc.
9055 South McKerny Street
Tempe, Arizona 85284-2946
Telephone (480) 783-0201
Fax (480) 783-0360

2	TITLE	B4003-8VM-40 (DE-006) TEST BOARD 8MIL 4003 VL MICR
---	-------	---

DRN BY: JAC	DATE: 02/19/20
SCALE:	4:1
SHEET: 1 OF 1	

DWG. NO.

79Y69109

REV.
A